



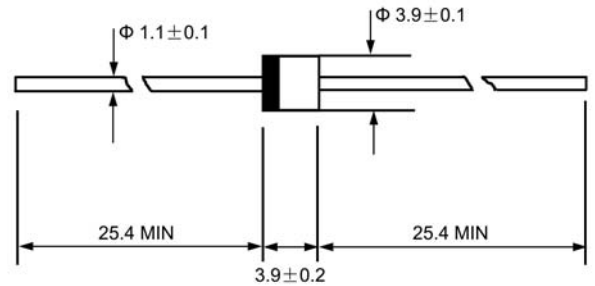
Features

- ◇ Low cost
- ◇ Diffused junction
- ◇ Low leakage
- ◇ Low forward voltage drop
- ◇ High current capability
- ◇ Easily cleaned with Freon, Alcohol, Isopropanol and similar solvents
- ◇ The plastic material carries U/L recognition 94V-0

Mechanical Data

- ◇ Case: JEDEC R--3, molded plastic
- ◇ Polarity: Color band denotes cathode
- ◇ Weight: 0.021 unces, 0.58 grams
- ◇ Mounting position: Any

R - 3



Dimensions in millimeters

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate by 20%.

		FR 251	FR 252	FR 253	FR 254	FR 255	FR 256	FR 257	UNITS
Maximum recurrent peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current 9.5mm lead length, @ $T_A=75^\circ C$	$I_{F(AV)}$	2.5							A
Peak forward surge current 8.3ms single half-sine-wave superimposed on rated load @ $T_J=125^\circ C$	I_{FSM}	150.0							A
Maximum instantaneous forward voltage @ 2.5 A	V_F	1.3							V
Maximum reverse current @ $T_A=25^\circ C$ at rated DC blocking voltage @ $T_A=100^\circ C$	I_R	5.0 100.0							μA
Maximum reverse recovery time (Note1)	t_{rr}	150			250	500		ns	
Typical junction capacitance (Note2)	C_J	22							pF
Typical thermal resistance (Note3)	$R_{\theta JA}$	35							$^\circ C/W$
Operating junction temperature range	T_J	- 55---- +150							$^\circ C$
Storage temperature range	T_{STG}	- 55---- + 150							$^\circ C$

NOTE:1. Measured with $I_F=0.5A$, $I_R=1A$, $I_{rr}=0.25A$.

2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

3. Thermal resistance from junction to ambient.

Ratings AND Characteristic Curves

FIG.1 – TYPICAL FORWARD DERATING CURVE

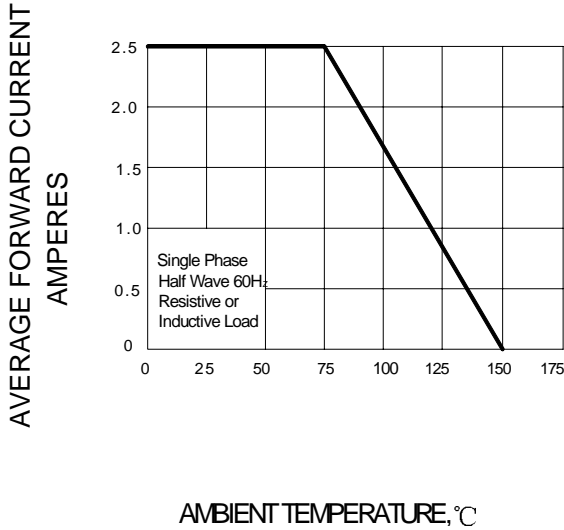


FIG.2- FORWARD SURGE CURRENT

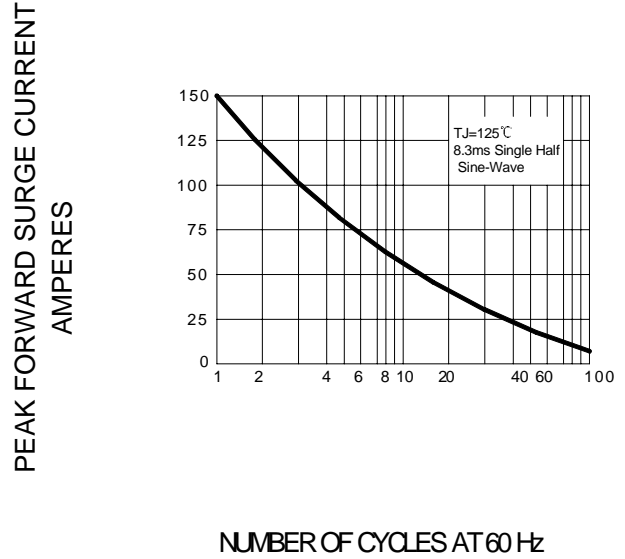


FIG.3-TYPICAL JUNCTION CAPACITANCE

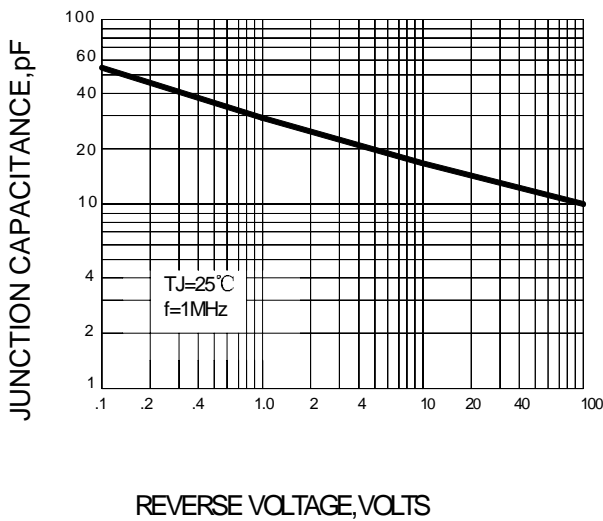


FIG.4 –TYPICAL FORWARD CHARACTERISTIC

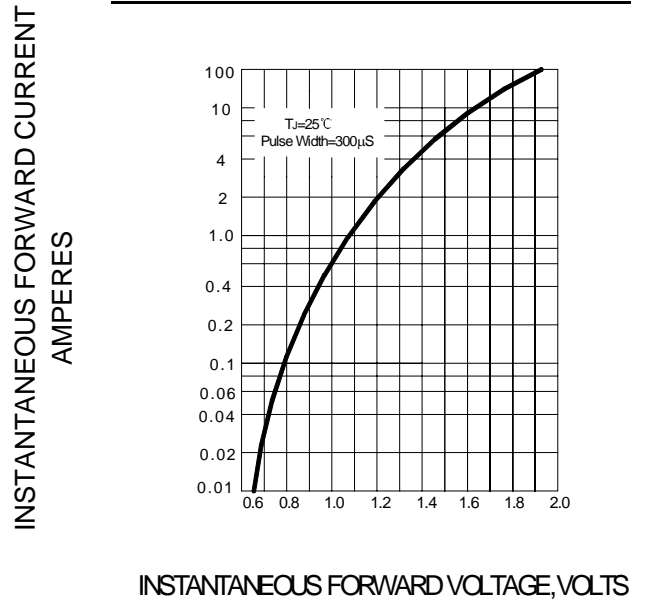
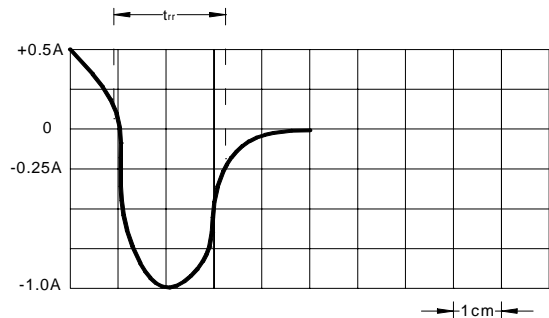
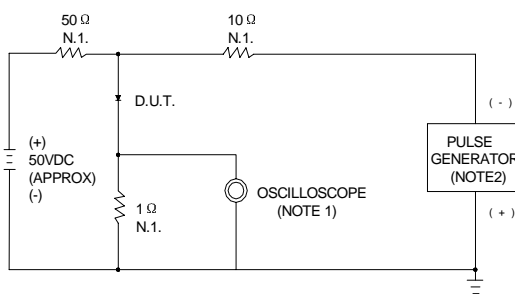


FIG.5 – REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM



NOTES: 1. RISE TIME=7ns MAX. INPUT IMPEDANCE=1MΩ, 22pF

2. RISE TIME=10ns MAX. SOURCE IMPEDANCE=50Ω

SET TIME BASE FOR 50/100 ns/cm